

To: **Technology Unit: 2814**
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**CERTIFICATION OF FACSIMILE TRANSMISSION**

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 Tommie Chambers

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NAME OF INVENTOR(S): Yew	
TITLE OF INVENTION: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE	
TI FILE NO.: TI-26239.1	DEPOSIT ACCT. NO.: 20-0668
FAXED: 11-12-04 DUE: 11/06/2004 ATTY/SECY: WDS/MC	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/612,129 Filing Date: 7/2/2003	

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Texas Instruments Incorporated
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 Dallas, TX 75265

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yew, et al. Docket No: TI-26239.1
 Serial No: 10/612,129 Examiner: Cao, Phat X.
 Filed: 7/2/2003 Art Unit: 2814
 For: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE

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NOTICE OF APPEAL FROM THE PRIMARY EXAMINER
TO THE BOARD OF APPEALS

Assistant Commissioner for Patents
 PO Box 1450
 Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATION OF FACSIMILE TRANSMISSION I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on the date shown below:

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11-12-04

Applicant hereby appeals to the Board of Appeals from the decision mailed August 6, 2004, of the Primary Examiner finally rejecting Claims 1-2, and 4-15.

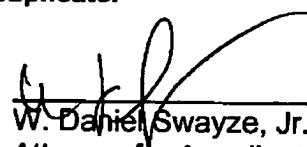
The item(s) checked below are appropriate:

1. An extension of time to respond to the final rejection

was granted on _____.
 is requested for 1 month.
2. A timely response to the final rejection has been filed, as provided in 841 O.G. 1411.
3. Fee \$340.00:

Not required (Fee paid in prior appeal)
 The Commissioner of Patents is hereby authorized to charge any fees which may be required or credit any overpayment to the deposit account of Texas Instruments Incorporated, Account No. 20-0668. This form is submitted in duplicate.

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 Attorney for Appellant
 Reg. No. 34,478